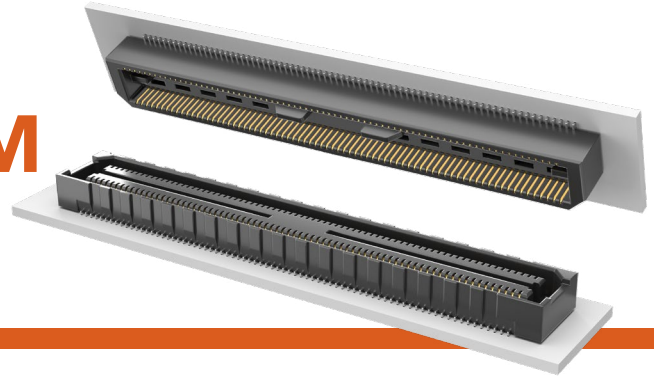


BASIC BLADE & BEAM HEADER & SOCKET

(0.635 mm) .025" PITCH • BTS/BSS SERIES



BTS
Mates:
BSS

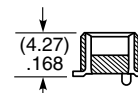
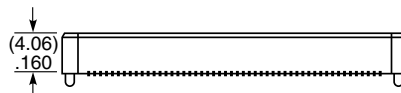
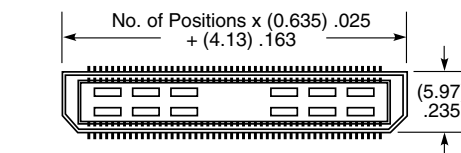
BSS
Mates:
BTS

SPECIFICATIONS

Insulator Material:
Liquid Crystal Polymer
Terminal Material:
Phosphor Bronze
Contact Material:
Phosphor Bronze
Plating:
Au or Sn over 50 μ " (1.27 μ m) Ni
Current Rating:
1.8 A per pin
(2 pins powered)
Operating Temp Range:
-55 °C to +125 °C

PROCESSING

Lead-Free Solderable:
Yes
SMT Lead Coplanarity:
(0.10 mm) .004" max



BTS	NO. OF POSITIONS PER ROW	01	PLATING OPTION	D	A	OTHER OPTION
	-025, -050, -075, -100		-F = Gold Flash on contact, Matte Tin on tail -L = 10 μ " (0.25 μ m) Gold on contact, Matte Tin on tail			-K = (7.00 mm) .275" DIA Polyimide Film Pick & Place Pad -TR = Tape & Reel (~100 positions max.)

-FR
= Full Reel Tape & Reel (must order max. quantity per reel; contact Samtec for quantity breaks) (~100 positions max.)

BSS	NO. OF POSITIONS PER ROW	01	PLATING OPTION	D	A	OTHER OPTION
	-025, -050, -075, -100		-F = Gold Flash on contact, Matte Tin on tail -L = 10 μ " (0.25 μ m) Gold on contact, Matte Tin on tail			-TR = Tape & Reel (~100 positions maximum) -FR = Full Reel Tape & Reel (must order maximum quantity per reel; contact Samtec for quantity breaks) (~100 positions maximum)

ALSO AVAILABLE

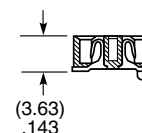
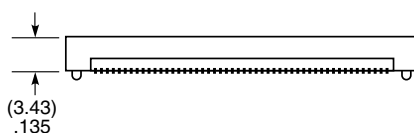
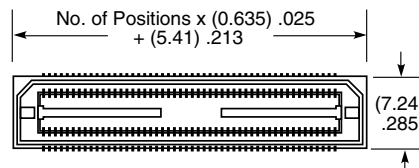
MOQ Required

30 μ " (0.76 μ m) Gold
Other platings
Other positions

MATED HEIGHT

LEAD STYLE	MATED HEIGHT*
-01	(5.00 mm) .197"

*Processing conditions will affect mated height.



Note:
Some lengths, styles and options are non-standard, non-returnable.